

General Description

The AAT7551 is a dual low threshold MOSFET designed for the battery, cell phone, and PDA markets. Using AnalogicTech™'s ultra high density MOSFET process and space saving small outline J-lead package, performance superior to that normally found in a TSOP-6 footprint has been squeezed into the footprint of a SC70 package.

Features

- $V_{DS(MAX)} = -20V$ $I_{D(MAX)}^{1} = -2.7A @ 25°C$
- Low $R_{DS(ON)}$:

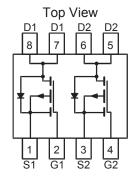
 100 mΩ @ V_{GS} = -4.5V

 175 mΩ @ V_{GS} = -2.5V

Dual SC70JW-8 Package

Applications

- **Battery Packs**
- Cellular & Cordless Telephones
- Battery-powered portable equipment



Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Description		Value	Units	
V _{DS}	Drain-Source Voltage		-20	V	
V _{GS}	Gate-Source Voltage		±12	, v	
I _D	Continuous Drain Current @ T _J =150°C ¹	T _A = 25°C	±2.7		
		T _A = 70°C	±2.2	Α	
I _{DM}	Pulsed Drain Current ²		±8		
I _S	Continuous Source Current (Source-Drain Diode) 1		-0.6		
P _D	Maximum Power Dissipation ¹	T _A = 25°C	1.2	W	
		T _A = 70°C	0.75	VV	
T_J, T_{STG}	Operating Junction and Storage Temperature Range		-55 to 150	°C	

Thermal Characteristics

Symbol	Description	Тур	Max	Units	
$R_{\theta JA}$	Junction-to-Ambient steady state 1	132	165		
$R_{\theta JA2}$	Junction-to-Ambient t<5 seconds 1	83	104	°C/W	
$R_{\theta JF}$	Junction-to-Foot 1	60	72		

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Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Description	Conditions	Min	Тур	Max	Units
DC Charac	DC Characteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-20			V
R _{DS(ON)}	Drain-Source ON-Resistance ²	V _{GS} =-4.5V, I _D =-2.7A		80	100	mΩ
		V _{GS} =-2.5V, I _D =-2.0A		140	175	
I _{D(ON)}	On-State Drain Current ²	V _{GS} =-4.5V, V _{DS} =-5V (Pulsed)	-8			Α
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=-250\mu A$	-0.6			V
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	nA
I _{DSS}	Drain Source Leakage Current	V _{GS} =0V, V _{DS} =-20V			-1	
		V_{GS} =0V, V_{DS} =-16V, T_J =70°C ³			-5	μΑ
9 _{fs}	Forward Transconductance ²	V _{DS} =-5V, I _D =-2.7A		4		S
Dynamic C	Dynamic Characteristics ³					•
Q_{G}	Total Gate Charge	V_{DS} =-10V, R_{D} =3.7 Ω , V_{GS} =-4.5V		5.9		
Q_{GS}	Gate-Source Charge	V_{DS} =-10V, R_{D} =3.7 Ω , V_{GS} =-4.5V		1		nC
Q_{GD}	Gate-Drain Charge	V_{DS} =-10V, R_{D} =3.7 Ω , V_{GS} =-4.5V		2		
t _{D(ON)}	Turn-ON Delay	V_{DS} =-10V, R_D =3.7 Ω , V_{GS} =-4.5V, R_G =6 Ω		22		
t_R	Turn-ON Rise Time	V_{DS} =-10V, R_{D} =3.7 Ω , V_{GS} =-4.5V, R_{G} =6 Ω		10		ns
t _{D(OFF)}	Turn-OFF Delay	V_{DS} =-10V, R_{D} =3.7 Ω , V_{GS} =-4.5V, R_{G} =6 Ω		20		115
t _F	Turn-OFF Fall Time	V_{DS} =-10V, R_{D} =3.7 Ω , V_{GS} =-4.5V, R_{G} =6 Ω		40		
Source-Dra	Source-Drain Diode Characteristics					
V _{SD}	Source-Drain Forward Voltage ²	V _{GS} =0, I _S =-2.7A			-1.3	V
Is	Continuous Diode Current ¹				-0.6	Α

Note 1: Based on thermal dissipation from junction to ambient while mounted on a 1" x 1" PCB with optimized layout. A 5 second pulse on a 1" x 1" PCB approximates testing a device mounted on a large multi-layer PCB as in most applications. $R_{\theta JF} + R_{\theta FA} = R_{\theta JA}$ where the foot thermal reference is defined as the normal solder mounting surface of the device's leads. $R_{\theta JF}$ is guaranteed by design, however $R_{\theta CA}$ is determined by the PCB design. Actual maximum continuous current is limited by the application's design.

Note 2: Pulse test: Pulse Width = 300 μ s

Note 3: Guaranteed by design. Not subject to production testing.

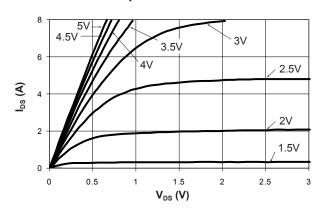
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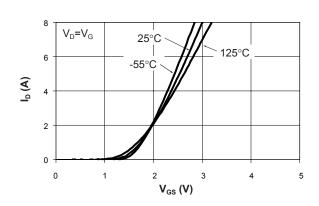
Typical Characteristics

 $\overline{(T_1 = 25^{\circ}\text{C unless otherwise noted)}}$

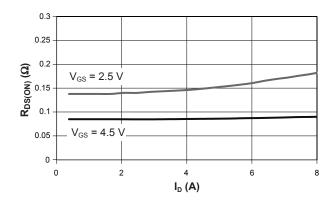
Output Characteristics



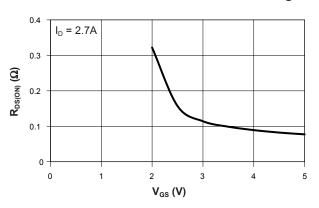
Transfer Characteristics



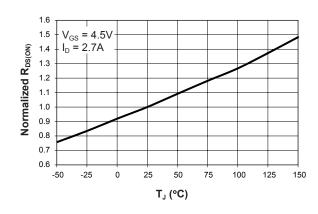
On-Resistance vs. Drain Current



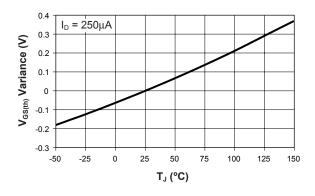
On-Resistance vs. Gate to Source Voltage



On-Resistance vs. Junction Temperature



Threshold Voltage



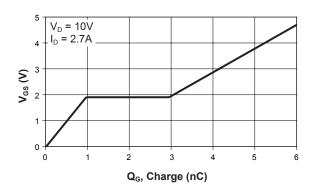
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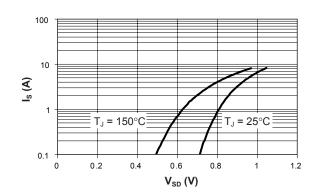
Typical Characteristics

 $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

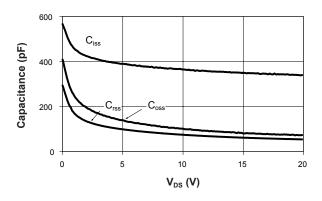
Gate Charge



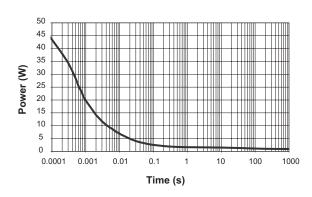
Source-Drain Diode Forward Voltage



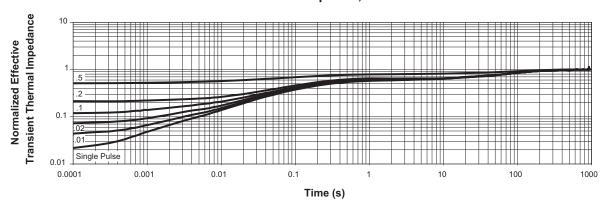
Capacitance



Single Pulse Power, Junction to Ambient



Transient Thermal Response, Junction to Ambient



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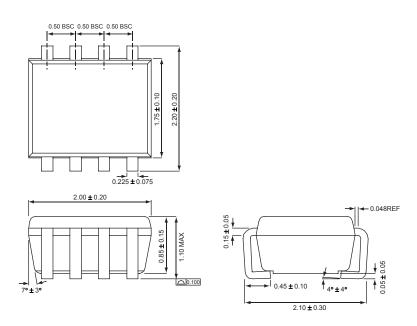
Ordering Information

Package	Marking ¹	Part Number (Tape and Reel)
SC70JW-8	KDXYY	AAT7551IJS-T1

Note 1: XYY = assembly and date code.

Package Information

SC70JW-8



All dimensions in millimeters.

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